

ELECTRONICS

*Electronics Capabilities*



# CVD DIAMOND DELIVERS A COOL COMPETITIVE ADVANTAGE

——— *Our CVD synthetic diamond is the most thermally conductive material. In electronics, it brings a new dimension to thermal management, extending device life time, reducing device footprint as well as offering performance and efficiency gains. Where power, temperature and reliability are critical factors, CVD diamond transforms competitive advantage in electronic thermal management.*

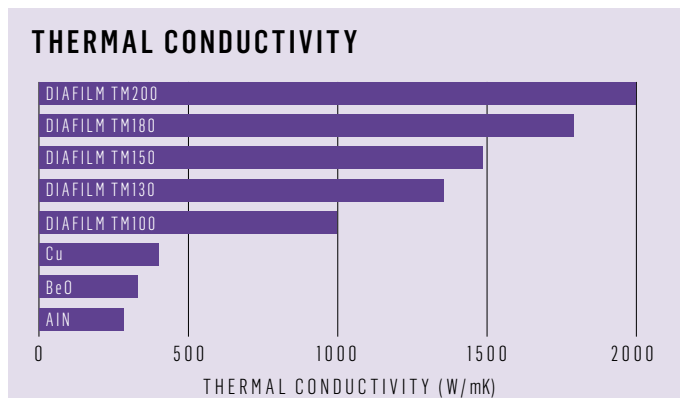
# INCREASE PERFORMANCE, EFFICIENCY AND DEVICE LIFETIME

- Leveraging synthetic diamond's unparalleled thermal properties allows semiconductor design engineers to address today's critical challenges such as improved reliability and increased power density on a smaller footprint, thereby delivering world-leading competitive advantage to both device and system manufacturers alike.
- Combining low weight, electrical insulation, mechanical strength, low toxicity and low dielectric constant with a room-temperature thermal conductivity up to 5 times higher than copper makes microwave CVD diamond the optimal heat spreader material for device and package designers.
- Using over 25 years of experience, Element Six tailors diamond properties to meet its customers' specific performance/cost requirements and custom cuts and metalizes diamond to help customers integrate singulated heat spreaders into their modules and systems.
- CVD diamond enables dramatic increases in lifetime and/or power and reduced operating costs for the latest semiconductor GaN devices.

## TRANSFORMING THERMAL MANAGEMENT PERFORMANCE

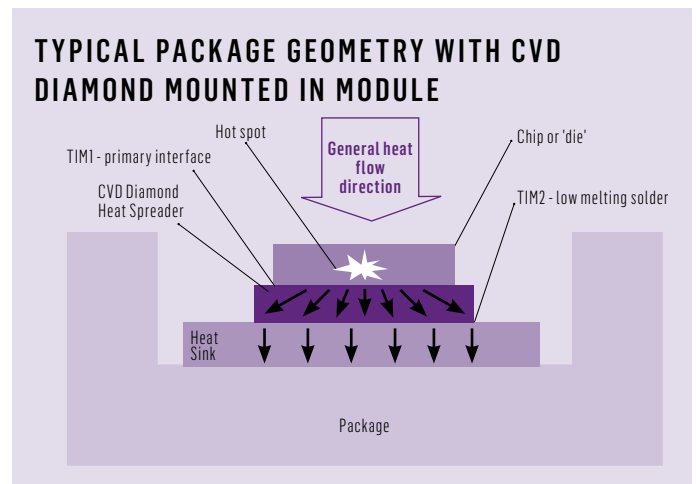
### HIGHEST ROOM-TEMPERATURE THERMAL CONDUCTIVITY OF ANY MATERIAL

Heat is the single biggest cause of failure in electronics. Statistically, reducing the operating junction temperature by 10°C can double a device lifetime. CVD diamond outperforms today's common materials for thermal management, such as copper, silicon carbide, and aluminium nitride by factors of 3 to 10 times.



## ELEMENT SIX CVD DIAMOND EXPERTISE OPTIMIZES CUSTOMER IMPLEMENTATION

CVD diamond can be made with thicknesses from 100 to 2000 microns and in diameters up to 140 mm. Laser cutting and polishing capabilities provide our customers the geometries, surface flatness and low roughness to meet their specific requirements. Our metallization expertise gives our customers a functional material they can use in die bonding with low thermal barrier resistances.



## TYPICAL APPLICATIONS

### HIGH-POWER RF DEVICES

- Base station RF amplifiers
- Satellite RF uplink amplifiers
- Microwave amplifiers

### HIGH-POWER OPTOELECTRONICS

- Laser diodes and laser diode arrays
- Optical planar IC modules
- High-brightness LEDs

### HIGH VOLTAGE POWER DEVICES

- Automotive sub systems
- Aerospace sub systems
- Energy distribution
- DC/DC converters

### SEMICONDUCTOR EQUIPMENT

- Characterization testing
- Die-attachment processes

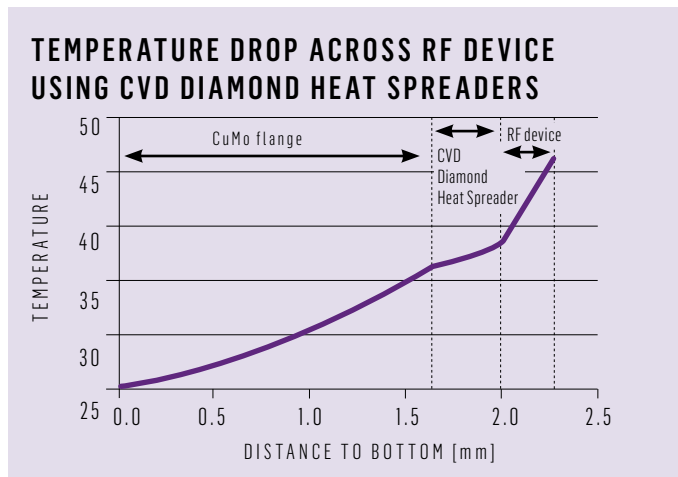
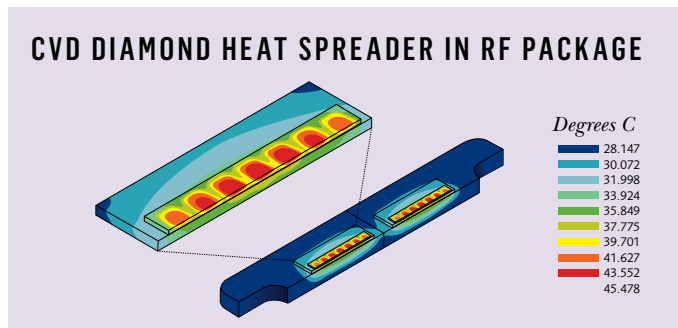
# RAPIDLY EMERGING TECHNOLOGY APPLICATIONS

## HIGH-POWER RF AND OPTOELECTRONICS

### HIGHER POWER AT LOWER OPERATING TEMPERATURE

CVD enables high-power RF and optoelectronic devices to:

- Run at higher power levels without increasing junction operating temperature
- Run at the same power level, but much cooler, thereby increasing lifetimes and reliability
- Wide optical transmission enables CVD diamond heat spreaders to operate within an optical path, such as in laser cavities, without optical performance degradation



Example of RF devices mounted on CVD diamond heat spreader in module. Temperature drops precipitously from junction to base due to CVD diamond's exceedingly high thermal conductivity.

## HIGH-VOLTAGE POWER DEVICES

### SMALLER, FASTER, HIGH-VOLTAGE POWER SYSTEMS

CVD diamond delivers:

- Improved reliability and increased efficiency by lowering device operating temperature
- Reduced system weight and footprint
- Reduction or elimination of auxiliary cooling systems

## SEMICONDUCTOR ASSEMBLY & TEST

### LONGER TESTING TIME AND EVENLY ATTACHED DIE

CVD diamond enables longer testing time during semiconductor device characterization by keeping them colder during stress testing and characterization. CVD diamond also ensures heat is rapidly and evenly spread across the entire semiconductor area during die attachment, ensuring strong and reliable contact.

## NEW ADVANCED CERAMIC MATERIAL

### COST-EFFECTIVE HIGH-VOLTAGE INSULATION AND THERMAL MANAGEMENT

Element Six offers an advanced AlN/cBN material with higher voltage breakdown than AlN while maintaining excellent thermal conductivity, providing an attractive price:performance ratio for power-electronics systems.

## PARTNERSHIP IN APPLICATIONS DEVELOPMENT

Our specialised team of application engineers and processing technologists can help you to design the right component for your application. Using the latest computer modelling system the ultimate performance of a component can be accurately predicted before manufacture. We recommend and provide the optimal size, shape, and thickness and work with customers to most effectively integrate diamond into their applications.

## ADVANTAGES OF CVD DIAMOND

- Highest room temperature thermal conductivity of any material
- Electrically insulating
- High mechanical strength
- Very low weight
- Chemical inertness and low toxicity
- Broad range of diamond bonding solutions
- Range of thicknesses across large areas available
- Low roughness with high flatness possible

## ELEMENT SIX

Element Six, part of the De Beers Group of Companies, designs, develops and produces synthetic diamond and other supermaterials, and operates worldwide with primary manufacturing facilities in China, Germany, Ireland, South Africa, the UK and US.

Element Six supermaterial solutions are used in applications such as cutting, grinding, drilling, shearing and polishing, while the extreme properties of synthetic diamond beyond hardness are opening up new applications in a wide array of industries such as optics, power transmission, water treatment, semiconductors and sensors.

If you would like to know more about Element Six please visit our website [www.e6.com/thermal](http://www.e6.com/thermal) or contact us at any of the addresses below.

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